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Atomic Layer Growth of InSe and Sb$_2$Se$_3$ Layered Semiconductors and Their Heterostructure

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Abstract: Metal chalcogenides based on the C–M–M–C (C = chalcogen, M = metal) structure possess several attractive properties that can be utilized in both electrical and optical devices. We have shown that specular, large area films of $\gamma$-InSe and Sb$_2$Se$_3$ can be grown via atomic layer deposition (ALD) at relatively low temperatures. Optical (absorption, Raman), crystalline (X-ray diffraction), and composition (XPS) properties of these films have been measured and compared to those reported for exfoliated films and have been found to be similar. Heterostructures composed of a layer of $\gamma$-InSe (intrinsically n-type) followed by a layer of Sb$_2$Se$_3$ (intrinsically p-type) that display diode characteristics were also grown.

Keywords: atomic layer deposition; heterostructure; pn diode

1. Introduction

The unique properties of graphene have drawn attention to other 2-dimensional (2D) materials, in particular metal chalcogenides, which can behave as metals, insulators, or semiconductors [1–3]. These semiconductors are of particular interest for the fabrication of the future generation of field effect transistors (FETs) and optoelectronic devices. These layered materials can be used as single or a few atomic layer thick films, absent of dangling bonds which allows for better electrostatic control of carrier transport; hence, they are ideal for downscaling of FETs. The ability to tune the direct band gap of many of these materials, by controlling their thickness, allows further flexibility for the design and fabrication of optoelectronic devices. However, to date, most attention has been focused on 2D transition metal dichalcogenides of structure C–M–C (C = chalcogen, M = metal), where one metal atom is sandwiched between two chalcogen atoms [4–7]. There are other forms of metal chalcogenides that are equally intriguing. Among these is the C–M–M–C family, which has been drawing more attention [8,9]. These materials have been used to produce photocatalysts, photo-detectors, image sensors, and transistors with high electron mobility [10–13]. We are currently investigating 2D semiconductor layers of this family of chalcogenide material that are composed of two metal and two Se atoms, Se–M–M–Se (M = In, Sb) grown via atomic layer deposition (ALD). Our objective is to demonstrate the growth of uniform, large area films that may in the future be utilized for the fabrication of electronic and optical devices. Our objective in this communication is to demonstrate that uniform and smooth films of InSe and Sb$_2$Se$_3$, both belonging to the C–M–M–C family of metal chalcogenides, can be grown over large areas using ALD. The properties of thin films grown using this approach, and their heterostructure are presented below.

InSe has several polytypes, however the $\beta$-phase and $\gamma$-phase are the two common forms of its crystal structure [14]. In this work, only the $\gamma$-InSe phase is considered which crystallizes into stacked hexagonal layers. The vertical stacking of this material is composed of Se–In–In–Se sheets, where each
sheet is weakly bound to its neighboring sheets by the van der Waals force [14]. It is interesting to note that while bulk InSe has a direct band gap (1.2 eV), reduction of its thickness first leads to a wider band gap due to quantum confinement, however further reduction of the thickness to a few layers results in a strong decrease of the photoluminescence. One of the reasons for this attenuation has been attributed to direct-to-indirect bandgap crossover, while another explanation has been attributed to the enhancement of non-radiative recombination processes in the thin flakes [15,16]. To date, InSe films have been produced mostly via chemical vapor deposition (CVD), sputtering, exfoliation, and electrodeposition [15,17–20]. In these cases, the films are either small, on the order of a few tens of micrometers per side (exfoliation) or are composed of flakes or platelets.

Unlike InSe, Sb$_2$Se$_3$ is a narrow band gap, layered metal chalcogenide (Se–Sb–Sb–Se) that has a single phase [21]. It is a direct band gap semiconductor with a layered structure and an orthorhombic structure [22]. The films consist of staggered, parallel layers of 1D (Sb$_4$Se$_6$)$_n$ ribbons that are composed of strong Sb–Se bonds along the [001] direction. In the [100] and [010] directions, the ribbons are held in the stack by the weak van der Waals forces [23]. It has received attention as a thermoelectric material, and recently as a light sensitizer in photovoltaic devices because of its narrow band gap of about 1.1 eV–1.3 eV, which approaches the ideal Shockley–Queisser value [24–26]. These films have been produced via a number of methods, including thermal evaporation, chemical bath deposition, spray pyrolysis, pulsed laser deposition and electrochemical deposition [25,27–30].

2. Materials and Methods

InSe and Sb$_2$Se$_3$ films were grown in a Microchemistry F-120 ALD reactor (Microchemistry, Helsinki, Finland) that can handle two 50 mm × 50 mm substrates per run. The substrates for these films consisted of either p- or n-type Si wafers coated with a 320 nm thick film of thermal silicon oxide. Besides Si, plain glass slides and fluorinated tin oxide (FTO) coated glass plates were also used as substrates. The precursors for InSe growth were InCl$_3$ and H$_2$Se (8%, balance Ar). The In source temperature was set at 110 °C and the carrier gas was nitrogen. The pulse sequence per cycle was as follows; InCl$_3$ pulse width of 1 s; N$_2$ purge of 1.0 s; H$_2$Se pulse width of 1.5 s; followed by 1.0 s N$_2$ purge. Uniform film growth occurred over a temperature range of 310 °C to 380 °C. The films reported here were grown at 350 °C, where the growth rate was 0.05 nm per cycle. The pulse sequence for Sb$_2$Se$_3$ films was SbCl$_3$ (1 s), N$_2$ (1.5 s), H$_2$Se (1.5 s), and N$_2$ (1.5 s). Uniform films were produced over a temperature range of 270 °C to 320 °C. From this range, 300 °C was selected to grow the films, where the growth rate was 0.22 nm/cycle. Optimization of growth conditions was done mostly based on Raman analysis, which offered a quick turn-around. Besides Raman, the crystalline structure of these films was examined with X-ray diffraction (XRD) (Rigaku Corp., Tokyo, Japan), their composition with X-ray photoelectron spectroscopy (XPS) (Northrop-Grumman, Falls Church, VA, USA) and their band gaps with optical absorption. The surfaces of these films were examined with a scanning electron microscope (SEM) (FEI Corp, Hillsboro, OR, USA) and found to be featureless. Finally, InSe/Sb$_2$Se$_3$ heterostructures were grown and their current-voltage (I–V) profiles were examined.

3. Results

The surface morphology of the films was first checked with a Nomarski microscope and then with an SEM. When the growth process was optimized, the surfaces of both InSe and Sb$_2$Se$_3$ were smooth and featureless, as shown in Figure 1a,b. This is a major difference between films grown via ALD and other methods. Although we expect there to be grain boundaries, we were unable to detect them with the SEM. Also, no grain boundaries were visible with the electron backscatter diffraction (EBSD) method.
Figure 1. Scanning electron microscope (SEM) view of the surface of (a) InSe and (b) Sb$_2$Se$_3$.

The crystalline properties of the films were characterized using grazing-angle (0.5°) XRD. The XRD spectrum of a 17 nm thick InSe film is shown in Figure 2a. The spectrum is dominated by the [006] peak, followed by minor peaks, which are characteristic of the hexagonal structure of γ-InSe (JCPDS 40-1407). Also, the deposition of an orange film on the walls of the reactor is indicative of this phase of the InSe [31].

Figure 2. X-ray diffraction (XRD) spectrum of (a) InSe (b) Sb$_2$Se$_3$. 
The XRD spectrum of our antimonelite (Sb$_2$Se$_3$) film is shown in Figure 2b, where all of the diffraction peaks agree well with its orthorhombic crystal structure (JCPDS 15-0861). Major peaks are indexed to the diffraction planes. The crystal lattice parameters were calculated as $a = 1.159$ nm, $b = 1.175$ nm, and $c = 0.3949$ nm, that are consistent with the values reported in literature [32]. No peaks of any other phases were detected, which indicates that these films are of single phase and high purity.

Optical characterization involved Raman spectroscopy and absorption spectra of these films. The Raman spectrum of a 17 nm thick InSe film is shown in Figure 3a, where the excitation wavelength was 532 nm. It shows the signature peaks corresponding to both the in-plane (E) and out-of-plane (A) modes that are consistent with those reported for flakes of γ-InSe [15,18,33,34]. Comparing the InSe data in Figure 3a with published results for the bulk and thin films, we can identify the peaks at about 117 cm$^{-1}$, 175 cm$^{-1}$, and 205 cm$^{-1}$ with $A'_1$, $E'_{2g}$, and $A'_1$(LO) Raman modes, respectively. The peak at 205 cm$^{-1}$ is strongest in films that are at about 6 nm to 9 nm thick layers and then attenuates with increase in thickness. The peak at around 155 cm$^{-1}$ is distinctive for the γ phase of InSe and is related to the zone center mode of the crystal [35,36].

![Figure 3. Raman spectrograph of (a) γ-InSe (b) Sb$_2$Se$_3$.](image)

The Raman spectrum of the 15 nm thick Sb$_2$Se$_3$ thin film is shown in Figure 3b. It agrees well with previously reported data, where the main peak at 189 cm$^{-1}$ ($A'_2$$_{1u}$) is the characteristic Sb–Se stretching mode of the SbSe$_{3/2}$ pyramids. The two other peaks, at about 151 cm$^{-1}$ ($A''_{2u}$) and at about 125 cm$^{-1}$ ($E_{2g}$) are associated with the Sb–Sb bonds and Se–Se bonds, respectively [37–39].

Band gaps of these films were determined from their respective absorption spectra obtained from the films deposited on glass substrates. The absorbance of these films was recorded over a spectral
range of 300 to 1100 nm. Plots of the wavelength (in terms of energy E in eV) versus the absorbance InSe and Sb$_2$Se$_3$ films are plotted in Figure 4a,b, respectively. The intercept on the x-axis of the extrapolation of the linear portion of the slope corresponds to the band gap of the material. For the 17 nm thick InSe film, the intercept occurs at about 2.35 eV. This value is in good agreement with the band gap of γ-InSe, which is defined as the transition between the p$_x$ and p$_y$ orbital to the bottom of the conduction band that corresponds to an energy gap of 2.4 eV [15,18]. The band gap of γ-InSe is higher than the other phases, therefore this parameter can be used to discriminate it from the other phases [35]. From Figure 4b, a band gap value of 1.3 eV was determined for a 15 nm thick Sb$_2$Se$_3$ film. This value is within the range of 1.1 to 1.3 eV previously reported [21,40].

![Absorbance spectrum of (a) InSe (b) Sb$_2$Se$_3$.](image)

**Figure 4.** Absorbance spectrum of (a) InSe (b) Sb$_2$Se$_3$.

The chemical composition of both of these films was examined by X-ray photoelectron spectroscopy (XPS). The signature binding energies of In 3d$_{5/2}$ and In 3d$_{3/2}$, shown in Figure 5a, correspond to 452.47 eV and 444.88 eV, respectively. The Se 3d profile is deconvoluted to show the two, closely spaced binding profiles of the Se d$_{5/2}$ and d$_{3/2}$ of binding energies of 53.88 eV and 54.88 eV (Figure 5b). These values are in agreement with pure In$_2$Se$_3$ films [41]. The dip between the two peaks is an indication of oxidation of the films, which is not surprising since the samples were exposed to air for a short period of time before XPS analysis.

The XPS binding energy of Sb$_2$Se$_3$ is shown in Figure 6. The binding energies of Sb 3d$_{5/2}$ and 3d$_{3/2}$ are 529.83 eV and 539.03 eV as shown in Figure 6a. Detailed spectral deconvolution of the Se 3d high resolution XPS spectrum revealed that the binding energy of Se 3d$_{5/2}$ and 3d$_{3/2}$ are 54.43 eV and 55.23 eV, respectively, which is in good agreement with the expected binding energy of Sb$_2$Se$_3$ [25]. These binding energies were corrected by referencing the C 1s peak to 284.70 eV.

![Binding Energy (eV)](image)

**Figure 5.** Cont.
4. Discussion

In an ALD process, the choice of the precursors and substrates is important in order to produce a saturated chemisorbed layer of the first species during the initial phase of the growth [42]. Moreover, the deposition parameters such as the pulse widths and temperature must be optimized to produce this condition. Then, the growth will proceed layer by layer, which is ideal for growth of a 2D...
film. We have found that organometallic or chloride-based metal precursors (with sufficient vapor pressure) work well on SiO$_2$ covered substrates, as we have previously demonstrated with other metal chalcogenides \cite{5,43,44}.

The 2D materials, as described above, are composed of individual layers that are held together by the weak van der Waals force. Within each layer, the atoms are strongly bonded to each other in 2D via either valence or ionic bonds, and in the absence of dangling bonds. This allows stacking of two different 2D materials with different physical properties, crystalline parameters and crystal symmetry to grow heterojunctions and superlattices held together by the van der Waals force. This approach to grow 2D heterojunctions has been referred to as van der Waals epitaxy \cite{45}. We have grown heterostructures composed of 5 nm–10 nm thick InSe and 5 nm–7 nm thick Sb$_2$Se$_3$ layers by sequentially growing each layer on Si/SiO$_2$ substrates and FTO-coated glass substrates. While detailed electrical characterization of these films is underway, Hall effect was used to determine the intrinsic doping properties of each of these two films. The InSe films were found to be intrinsically n-type and Sb$_2$Se$_3$ were intrinsically p-type. On the FTO substrates, the first film deposited was InSe, followed by Sb$_2$Se$_3$, while keeping one part of the FTO surface covered to avoid any deposition. Small Au contacts were sputtered on top of the Sb$_2$Se$_3$ layer and Al on the FTO portion. The current–voltage (I–V) profiles of these samples were then examined.

A typical example of one of these samples is shown in Figure 7, which shows the characteristic profile of a pn diode. The leakage current with a reverse bias is shown (in log scale) in the inset. A maximum leakage current of $10^{-7}$ A was measured at $-1$ V bias. Since each precursor was introduced separately into the reactor for a surface reaction for a layer-by-layer growth, and we were working at a relatively low temperature, we do not expect significant intermixing at the interface. This heterojunction was grown at 310 °C, which overlaps the optimum range of both the materials. A one minute purge was introduced before starting the Sb$_2$Se$_3$ layer to ensure a sharp interface. In our previous work on SnS/WS$_2$ heterojunctions that were grown at a slightly higher temperature, there were no obvious signs of intermixing at the interface \cite{5}.

**Figure 7.** Current–voltage (I–V) profile of the InSe/Sb$_2$Se$_3$ pn junction.
5. Conclusions

In summary, ALD has been utilized to grow smooth and continuous layers of $\gamma$-InSe and Sb$_2$Se$_3$ layered metal chalcogenide on SiO$_2$-coated Si and glass substrates. Crystalline and optical properties, as well as the composition of these films are comparable to those produced by other means, especially exfoliation. The InSe and Sb$_2$Se$_3$ films show intrinsic n-type and p-type behaviors, respectively. A combination of these two films shows pn diode characteristics. These results show that ALD offers a viable path for producing large area films of metal chalcogenides for future industrial scale applications.

Author Contributions: Robert Browning, Neal Kuperman, Bill Moon and Raj Solanki all contributed equally.

Conflicts of Interest: The authors declare no conflict of interest.

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